

Formaldehyde Emissions from Composite Wood **Products**

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Outline

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- Formaldehyde
 - -Sources of formaldehyde in a composite wood product
- Composite Panel Emissions
 - Experimental Plan
 - Hardwood Plywood-Completed 6/2010
 Particleboard-Completed 4/2012
- Review of Commercially Available Adhesives

Sources of Free Formaldehyde In Composite Wood Products

- 1) <u>Native</u> free formaldehyde does exist in ALL wood in very small amounts
 - Processing (i.e. drying of wood, and pressing of panels) can result in more to be produced

Supplied by nature

Formaldehyde Produced: PRE panel making

Large Chamber Contribution: Low

Total Product Life Emission Potential: Low

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Sources of Free Formaldehyde - continued

- 2) <u>Process & Adhesive</u> Many adhesives contain bound formaldehyde, and when these molecules react they often PRODUCE ADDITIONAL free formaldehyde.
 - Catalyst and other processing parameters will impact formaldehyde levels
 - Emission levels directly related to the amount of formaldehyde formulated in the adhesive

Formaldehyde Produced: DURING panel making

Large Chamber Contribution: High

Total Product Life Emission Potential: Low-Med

Sources of Free Formaldehyde - continued

3) Hydrolysis (in use generated) - Some formaldehyde-based bonds are prone to reversing back to free formaldehyde when exposed to water

Largest long term contributor to emissions
Level is VERY dependent on conditions (relative humidity and temperature)
Not all formaldehyde bonds hydrolyze
Urea-formaldehyde (UF) is MOST easily
hydrolyzed

Formaldehyde Produced: POST panel making

Large Chamber Contribution: Very Low

Total Product Life Emission Potential: High

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"Produced" Formaldehyde

$$H$$
 H_{2N} H_{2N}

Formaldehyde

Urea

Urea-Formaldehyde

- Urea-formaldehyde (UF) is low-cost and reacts rapidly to form a strong bond
- Reaction is *reversible* and provides potential for long-term formaldehyde release

Adhesive Classifications

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NAF - (Prescription Based): "No added formaldehyde" as part of the resin cross linking structure for making hardwood plywood, particleboard, or medium density fiberboard. "No-added formaldehyde based resins" include, but are not limited to, resins made from soy, polyvinyl acetate, or methylene diisocyanate. (CARB Definition)

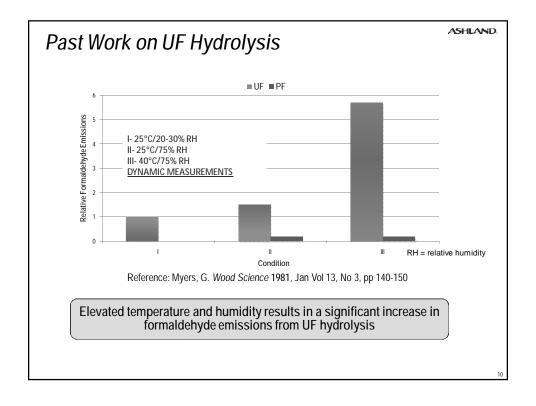
NAUF - (Prescription Based): No Added Urea Formaldehyde (USGBC, LEED)-Any adhesive with or without formaldehyde that DOES NOT contain any urea-formaldehyde

ULEF - (Emission Based): "Ultra-low-emitting formaldehyde (ULEF) resins" means resins formulated such that average formaldehyde emissions are consistently below the Phase 2 emission standards in section 93120.2, as provided in section 93120.3(d). (CARB Definition)

What does this mean??

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- Hydrolysis is often the largest contributor to formaldehyde emissions over the life of the product
- Current testing does NOT capture the propensity for a panel to generate this source of formaldehyde
- UF-based (MUF too) adhesives SHOULD be the primary concern for potential long-term formaldehyde emissions
- Other formaldehyde adhesives (NAUF) should still be monitored closely for emissions



Experimental Approach

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 Ashland collaborated with Dr. Charles Frihart of the U.S.D.A Forest Products Laboratory (FPL) in Madison, WI

Objective:

- Expand the previous work by George Myers to assess the new generation of UF-based resins (CARB Phase 2 capable)
- Initially evaluated hardwood plywood, and recently evaluated particleboard

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Experimental Plan

- Particleboard (PB) made with NAF and UF-based Adhesives
 - ¾" PB Specimens
 - CARB Phase 2 commercially produced panels made with UF/MUF adhesives
 - NAF panels laboratory produced (36" X 36")
 - BOTH produced with the same sourced commercial wood!
 - BOTH made with comparable adhesive levels and process parameters to achieve comparable strength
- · Desiccator method in sealed bottles
 - Modified EN 717-3
- Varying levels of humidity and temperature
- Aged Evaluation
 - Panels were conditioned for up to 14 weeks at 77 °F/50% relative humidity (RH) and then tested using a one day run at 77 °F/50%RH and 95 °F/100% RH

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Testing Method

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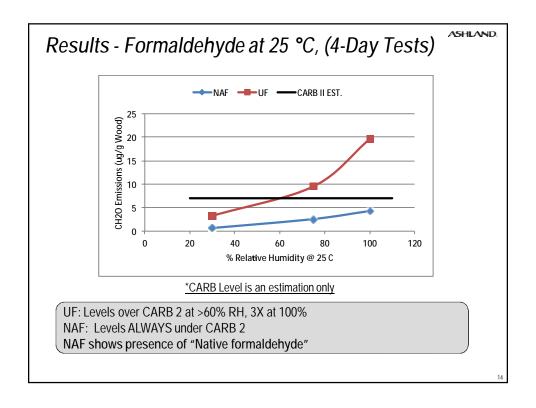
- Static (constant air)
 - -Desiccator (JIS A1460, ASTM D-5582)
 - -Flask (EN-717-3)

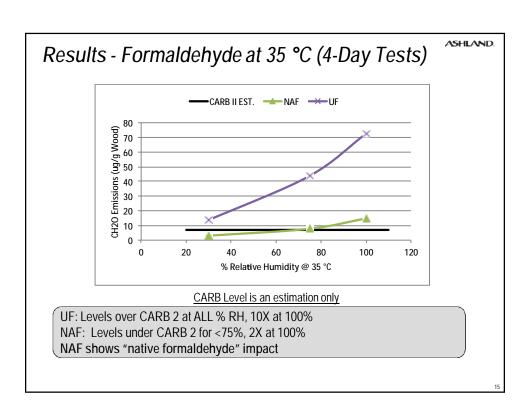
	EN-717-3	Our Method
Temperature	40 C	25 C and 35 C
Test Duration	3 hr	1-4 days
% Relative Humidity	100%	30, 75, 100%

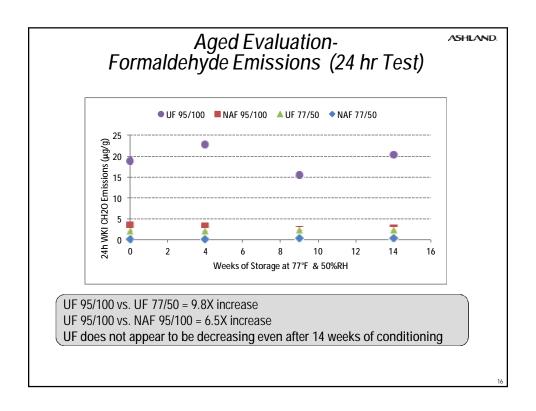
30% - Sat MgCl₂ 75% - Sat NaCl 100% - No salt



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ASHLAND. Adhesive-Product Attributes1 Class Туре Cost-in-Ease of Panel Cost-in-Ease of Panel Use Use **Properties** Use Use **Properties** None UF/MUF \bigcirc NAUF MF n/a n/a NAF pMDI n/a PVAc* n/a No Known Concerns Some Minor Concerns Some Major Concerns Significant Concerns Wide range of adhesive types are commercially available (1) Information presented is based on a combination of experimental data, literature discussions and consumer/producer interviews. Assessment can vary greatly depending on specific formulation. Chart is intended to serve as a general guideline.

Summary

- The use of UF-based resins in composite panels WILL result in significantly higher formaldehyde emissions when exposed to elevated temperature and/or humidity levels. The higher the temperature and the higher the humidity the higher the emissions will be.
- UF-based resins appear to have been developed to satisfy accepted emission based regulations, which are only achieved under the least challenging indoor environmental conditions (77 °F / 50% relative humidity).
- The current testing protocols are not adequate to predict long term emission potential at all conditions.
- NAUF resins, although generally less likely to hydrolyze, should be closely monitored as formulation and process parameters can greatly impact emission levels.
- There are alternative NAF and NAUF resins available to serve the needs of the market.

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